SPECIFICATIONS

CUSTOMER . CKR001

SAMPLE CODE . SE9665WRF-002-I08Q

MASS PRODUCTION CODE . PE9665WRF-002-I08Q

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 002

DRAWING NO. (Ver.) . JLMD- PE9665WRF-002-I08Q _ 001

PACKAGING NO. (Ver.) . JPKG- PE9665WRF-002-I08Q _ 001

Customer Approved

Date:

2014.03.10

Approved	Checked	Designer
閆偉	劉進	徐明菲

- Preliminary specification for design input
- Specification for sample approval

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History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
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		X			

Total : 26 Pages



Contents

1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics

2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics

3. QUALITY ASSURANCE SYSTEM

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

4. RELIABILITY TEST

4.1 Reliability Test Condition

5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Appendix: 1.LCM Drawing

2.LCM Packaging

Note: For detailed information please refer to IC data sheet: SITRONIX -ST7579-G2



1. SPECIFICATIONS

1.1 Features

1	
Item	Standard Value
Display Type	96 * 65 Dots
LCD Type	FSTN, Positive, White, Transmissive, Extended Temp.
Driver Condition	LCD Module :1/68 Duty, 1/9 Bias
Viewing Direction	6 O'clock
Weight	
Interface	3-line SPI (serial peripheral interface)
Driver IC	SITRONIX – ST7579-G2
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web site :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	34.0 (W) * 30.4 (L) * 3.1 (H)	mm
Viewing Area	27.8 (W) * 18.9 (L)	mm
Active Area	25.42 (W) * 16.88 (L)	mm
Dot Size	0.245 (W) * 0.24 (H)	mm
Dot Pitch	0.265 (W) * 0.26 (H)	mm

Note: For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	V_{DD}	-	-0.3	+3.6	V
LCD Driver Supply Voltage	V0-XV0	-	-0.3	+15	V
LCD Power driving voltage	VG,VM	-	-0.3	V_{DD}	V
Operating Temperature	T _{OP}	-	-20	70	°C
Storage Temperature.	T _{ST}	-	-30	80	°C
Storage Humidity	H _D	Ta<60 °C	20	90	%RH



1.4 DC Electrical Characteristics

 V_{DD} = 2.8±0.2V, V_{SS} = 0V, Ta = 25 $^{\circ}$ C

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	V_{DD}	-	2.6	2.8	3.0	V
"H" Input Voltage	V _{IH}	-	0.7V _{DD}	-	V _{DD}	٧
"L" Input Voltage	V _{IL}	-	Vss	-	0.3VDD	٧
"H" Output Voltage	V _{OH}	I _{OUT} =1mA	0.8V _{DD}	-	V _{DD}	V
"L" Output Voltage	V_{OL}	I _{OUT} =-1mA	Vss	-	0.2V _{DD}	V
Supply Current	I _{DD}	V _{DD} = 2.8V;V _{OP} = 8.5V; Pattern= Horizontal *1	-	0.3	0.5	mA
		-20°C	8.7	8.8	9.0	
LCM Driver Voltage	V _{OP} *2	25 ℃	8.3	8.5	8.7	V
		70℃	7.9	8.0	8.1	

NOTE: *1 The Maximum current display;

*2 The V_{OP} test point is V0~XV0.





1.5 Optical Characteristics

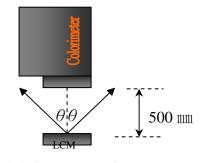
LCD Panel: 1/68 Duty, 1/9 Bias, $V_{LCD} = 8.5$ V, Ta = 25° C

Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Reference
Dannana Tima	Rise	tr		-	120	180	mo	Note 2
Response Time	Fall	tf	_	-	200	300	ms	Note 2
	Тор	θ+		-	20	-		
Viewing angle	Bottom	θ-	C>2.0	-	30	-		Note 1
range	Left	θL	C <u>></u> 2.0	-	20	-	_	Note i
	Right	θR		-	25	-		
Contrast Ra	tio	С	θ = 0°	-	3	-	-	Note 3
Average Bright (with LCD)		IV		85	110		cd/m ²	
CIE Color Coordinate (With LCD) *2		X	IF= 20 mA	0.23	0.28	0.33	-	Note 4
		Y		0.23	0.28	0.33	-	
Uniformity '	' 1	∆B		70	-	-	%	

Note 4:

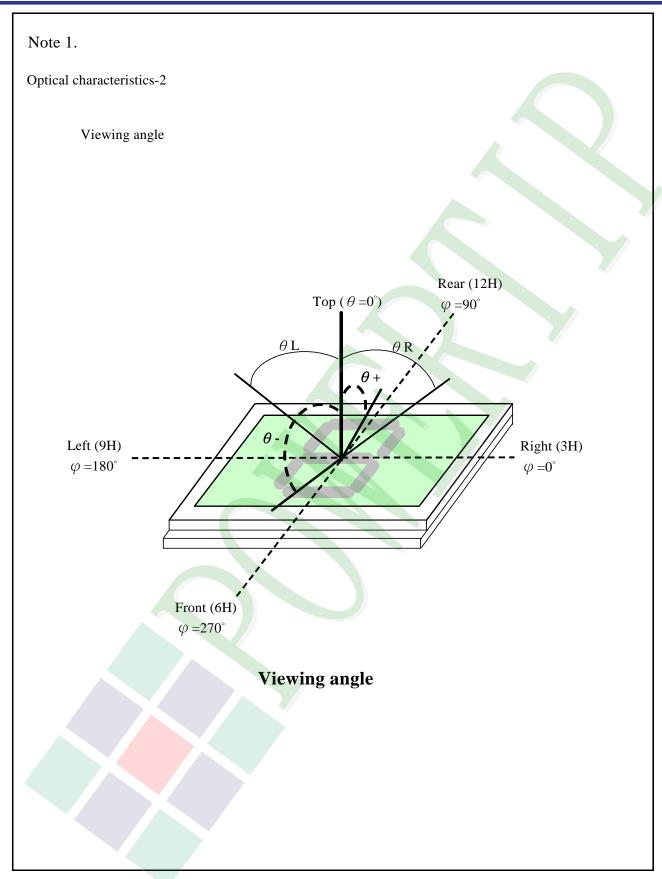
- 1 : △B=B(min) / B(max) * 100%
- 2 : Measurement Condition for Optical Characteristics:
 - a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b : Measurement Distance: $500 \pm 50 \text{ mm}$ $\rightarrow (\theta = 0^{\circ})$
 - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%



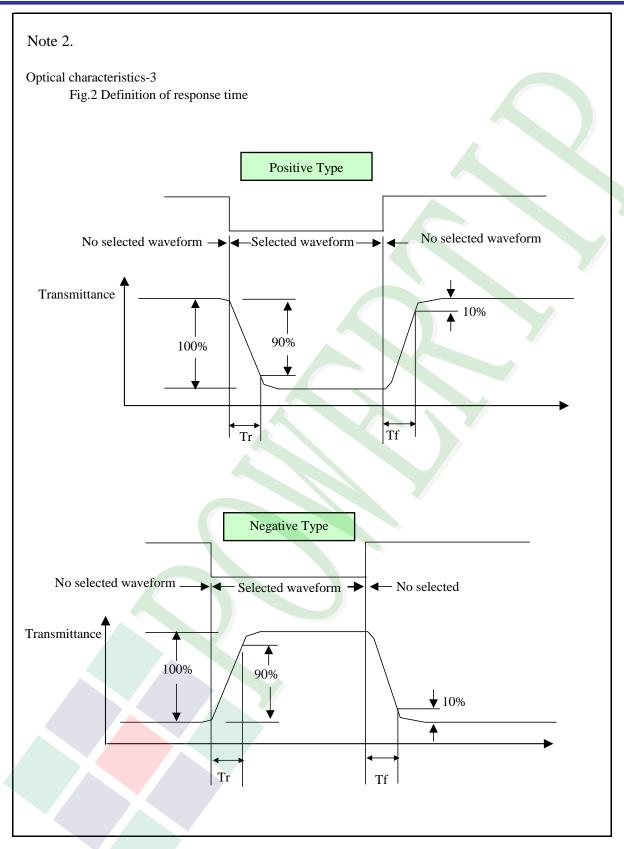


Colorimeter=BM-7 fast











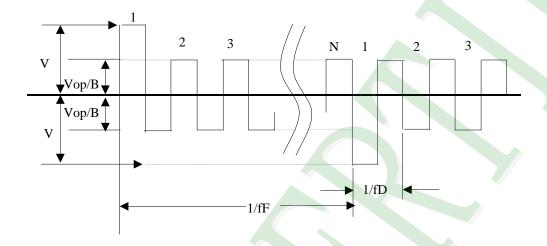
Electrical characteristics-2

※2 Drive waveform

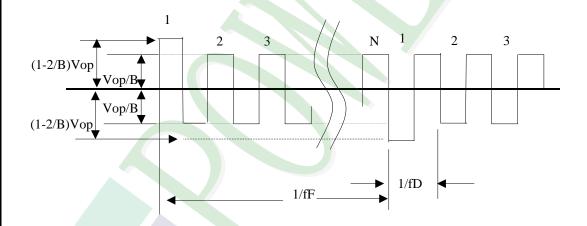
Vop: Drive voltage fF: Frame frequency 1/B: Bias fD: Drive frequency

N: Duty

(1) Selected waveform



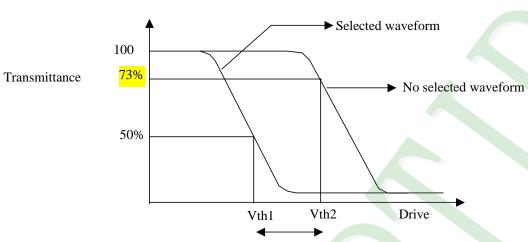
(2) Non- Selected wave form



Note:

Frame frequency is defined as follows: Common side supply voltage peak - to - peak /2 = 1 period

Note 3.: Definition of Vth



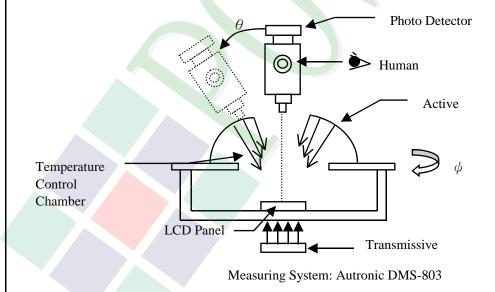
Active voltage range

	Vth1	Vth2
View direction	10°	40 °
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

※1 Contrast ratio

= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System





1.6 Backlight Characteristics

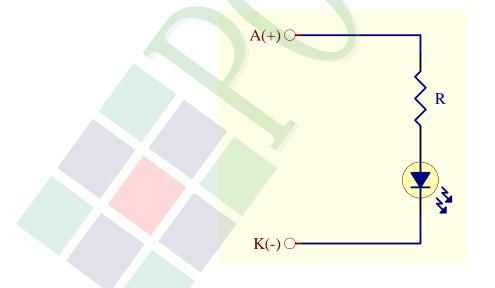
Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°C	-	30	mA
Reverse Voltage	VR	Ta =25°C	- /	5	V
Power Dissipation	PD	Ta =25°ℂ	-	105	mW

Electrical / Optical Characteristics

Item	Symbol Conditions		Min.	Тур.	Max.	Unit
Forward Voltage	VF IF= 20mA		3.1	3.3	3.5	V
Reverse Current	IR VR=5V			-	0.05	mA
Average Brightness (without LCD)	IV	IF= 20mA	400	500	600	cd/m ²
CIE Color Coordinate	Х	IF= 20mA	0.25	0.28	0.31	-
(without LCD)	Y	IF- ZUIIIA	0.25	0.28	0.31	-
Color			White			

Internal Circuit Diagram:





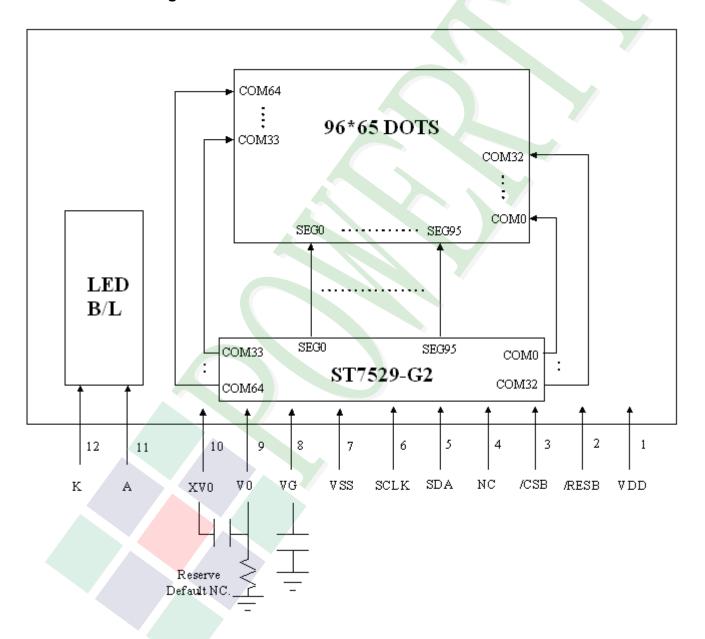
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram



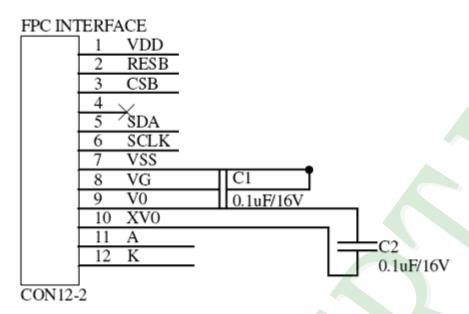


2.2 Interface Pin Description

Pin No.	Symbol	Function
1	VDD	Power supply.
2	/RESB	Reset input pin. When RESB is"L", internal initialization is executed.
3	/CSB	Chip select input pin. Interface access is enabled when CSB is "L".
4	NC	Not connection.
5	SDA	Serial data input,
6	SCLK	Serial clock input.
7	VSS	Ground.
8	VG	LCD driving voltage for segments. Connect a capacitor 0.1uF between this terminal and VSS.
9	V0	LCD driving voltage for commons at negative frame. Connect a capacitor 0.1uF between this terminal and the XV0 terminal.
10	XV0	LCD driving voltage for commons at positive frame. Connect a capacitor 0.1uF between this terminal and the V0 terminal.
11	А	Backlight LED anode input pin.
12	K	Backlight LED cathode input pin.



2.2.1 Application Notes:



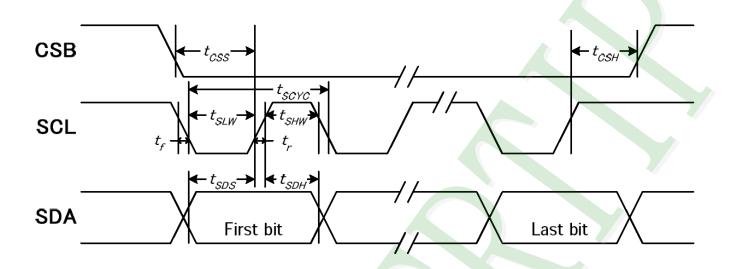
2.2.2 Refer Initial code:

```
void initial ()
{
   WriteCom(0x2b);
                        //FUNCTION SET H[1:0]=11
   WriteCom(0x0c);
                        //FRAME RATE:73HZ
   WriteCom(0x9b);
                         //BOOSTER SET 5X
                        //FUNCTION SET H[1:0]=00
   WriteCom(0x28);
   WriteCom(0x05);
                         //PRS=0 V0 programming range LOW
                         //FUNCTION SET H[1:0]=01
   WriteCom(0x29);
   WriteCom(0xbb);
                         //SET V0
   WriteCom(0x12);
                         //SET BIAS: 1/9
                         //FUNCTION SET H[1:0]=00
   WriteCom(0x28);
   WriteCom(0x80);
                         //SET X ADDRESS
   WriteCom(0x40);
                         //SET Y ADDRESS
   WriteCom(0x0c);
                         //DISPLAY CONTROL
}
```



2.3 Timing Characteristics

SERIAL INTERFACE (3-Line Interface)



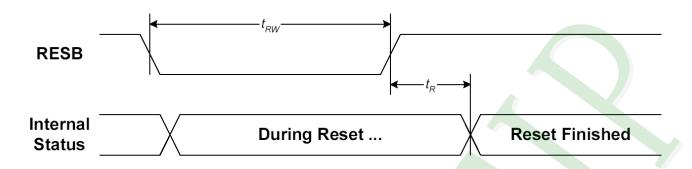
Item	Signal	Symbol	Condition	Min.	Max.	Unit
Serial clock period		tSCYC		180	_	
SCLK "H" pulse width	SCLK	tSHW		90	_	
SCLK "L" pulse width	4	tSLW		90	_	
Data setup time	SDA	tSDS		30	_	ns
Data hold time	SDA	tSDH		20	_	
CSB-SCLK time	CSB -	tCSS		30	_	
CSB-SCLK time	COB	tCSH		160	_	

^{*1} The input signal rise and fall time (tr, tf) are specified at 15 ns or less.

^{*2} All timing is specified using 20% and 80% of VDD1 as the standard.



RESET TIMING

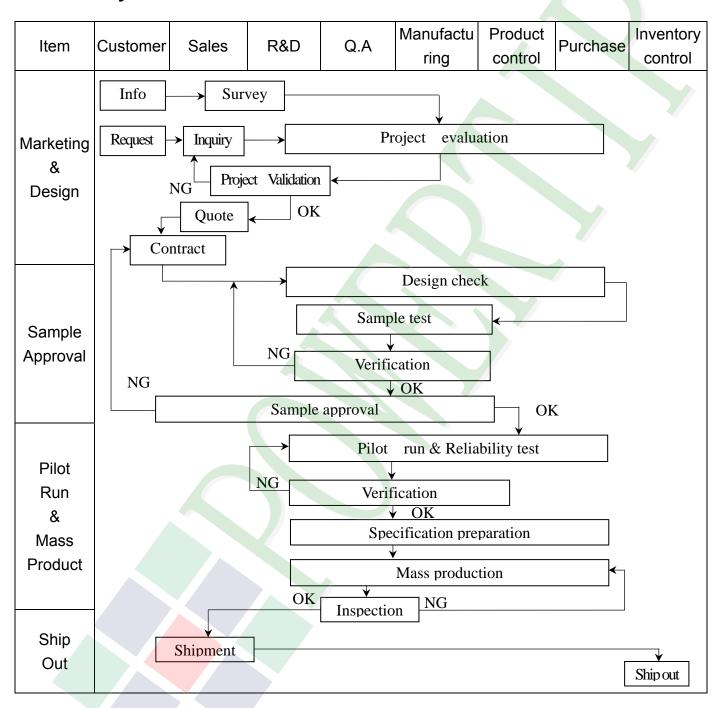


ltem	Symbol	Condition	Min.	Max.	Unit
Reset time	tR			2.0	
Reset "L" pulse width	tRW		2.0		us

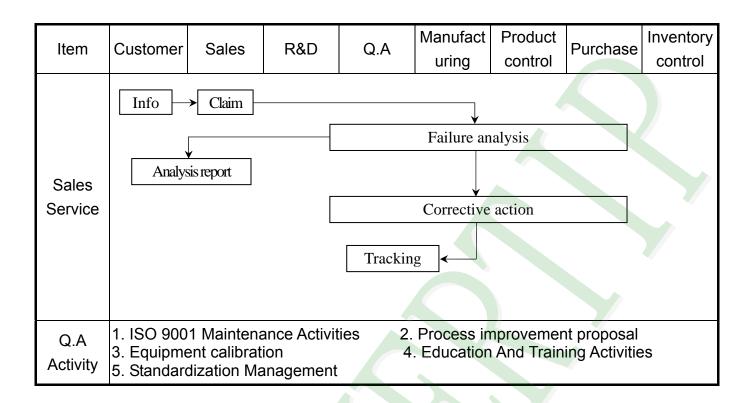


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2 Inspection Specification

- ◆Scope: The document shall be applied to LCD Module for Monotype and Color STN(Ver. 02).
- ♦ Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II.
- ◆Equipment : Gauge \ MIL-STD \ Powertip Tester \ Sample
- ◆Defect Level: Major Defect AQL: 0.4; Minor Defect: AQL: 1.5.
- **♦**OUT Going Defect Level : Sampling .
- ◆Manner of appearance test :
 - (1). The test be under 20W×2 fluorescent light 'and distance of view must be at 30 cm.
 - (2). Standard of inspection: (Unit: mm)
 - (3). The test direction is base on about around 45° of vertical line. (Fig. 1)
 - (4). Definition of area . (Fig. 2)

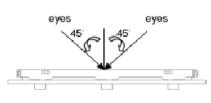


Fig.1

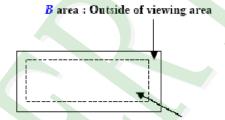


Fig. 2 A area: viewing area

♦ Specification:

NO	Item	Criterion	level
		1. 1 The part number is inconsistent with work order of Production.	Major
01	Product condition	1, 2 Mixed production types.	Major
		1, 3 Assembled in inverse direction.	Major
02	Quantity	2. 1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3. 1 Product dimension and structure must conform to Structure diagram.	Major
		4. 1 Missing line character and icon.	Major
04	Electrical Testing	4, 2 No function or no display.	Major
		4. 3 Output data is error.	Major
		4. 4 LCD viewing angle defect.	Major
		4. 5 Current consumption exceeds product specifications.	Major



<u> </u>		type and Color SIN .				ver. 02)
NO	Item	Criterion			level	
	Black or white dot `scratch` contamination 5. 1 Round type: 5. 1. 1 display only: • White and black spots on display ≤ 0. 30 mm, no more th 4 white or black spots present. • Densely spaced: NO more than two spots or lines within 3					
		5. 1. 2 Non-display : Dimension (diameter :	Ф) А	cceptance (C	P(tv)	Minor
	Round type	Φ≤0.10	7/ 1	Accept no d		Millor
	⇒l _× ⊄⊥	$0.10 < \Phi \leq 0.20$		3		
	<u> </u>	$0.20 < \Phi \le 0.30$		2		
05	- +	Total quantit		4		
	Φ-(x+y)/2					
		5. 1. 3 Line type:				
		Dimension		Acc	eptance (Q'ty)	
	Line type	Length (L) Widtl	1 (W)	A area	B area	
	_ / ¥w		$\mathbf{W} \leq 0.03$	Accept no dense	Don't count	
	→	$L \le 3.0$ 0.03 < V	$V \leq 0.05$	4	Don't count	
	-	$L \le 2.5$ 0.05 < 1	$V \leq 0.075$	4	Don't count	
			V > 0.075	A	s round type	
		Discouries (Allered as #2)		cceptance ((O'tv)	
		Dimension (diameter : Φ)	A are		B area	
		Φ ≤ 0, 20	Accept n	o dense	Don't count	
06	Polarizer	$0.20 < \Phi \leq 0.50$	3		Don't count	Minor
	Bubble	$0.50 < \Phi \le 1.00$	2		Don't count	
		$\Phi > 1.00$	0		Don't count	
		Total quantity	4		Don't count	
				•		



NO	Item	Criterion		
		Symbols: X: The length of crack Y: The width of crack. Z: The thickness of crack W: terminal length t: The thickness of glass a: LCD side length		
		7. 1 General glass chip: 7. 1. 1 Chip on panel surface and crack between panels:		
		Z Z Z X X X X X X X X X X X X X X X X X		
07	The crack of glass	SP SP [NG]	Minor	
		Seal width Z		
		X Y Z		
		≤ a Crack can't enter viewing area ≤1/2 t		
		≤ a Crack can't exceed the half of SP width. 1/2 t < Z ≤2 t		



NO	Item	Criterion			
	Symbols: X: The length of crack Y: The width of crack. Z: The thickness of crack W: terminal length t: The thickness of glass a: LCD side length 7. 1, 2 Corner crack:				
07	The crack of	$\begin{array}{c cccc} X & Y & Z \\ & \leq 1/5 \ a & \begin{array}{c} \text{Crack can't enter} \\ \text{viewing area} \end{array} & Z & \leq 1/2 \ t \\ & \leq 1/5 \ a & \begin{array}{c} \text{Crack can't exceed the} \\ \text{half of SP width.} \end{array} & 1/2 \ t < Z & \leq 2 \ t \end{array}$	Minor		
	glass	7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad: X X X X Z			
		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			
		Back Neglect			



NO	Item	Criterion		
		Symbols: X: The length of crack Y: The width of crack. Z: The thickness of crack W: terminal length t: The thickness of glass a: LCD side length		
		7.2.2 Non-conductive portion: W X X		
07	The crack of	X Y Z	Minor	
	glass	 ≤1/3 a ≤W ≤t O If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. 		
		7, 2, 3 Glass remain:		
		Y Z		



NO	Item	Criterion	Level
		8. 1 Backlight can't work normally.	Major
08	Backlight elements	8. 2 Backlight doesn't light or color is wrong.	Major
		8. 3 Illumination source flickers when lit.	Major
		9. 1 Pin type must match type in specification sheet.	Major
		9, 2 No short circuits in components on PCB or FPC.	Major
09	General appearance	9. 3 Product packaging must the same as specified on packaging specification sheet.	Minor
		9.4 The folding and peeled off in polarizer are not acceptable.	Minor
		9. 5 The PCB or FPC between B/L assembled distance (PCB or FPC) is $\leq 1,5$ mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

NO.	TEST ITEM	TEST CONDITION			
1	High Temperature Storage Test	Keep in +80±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.			
2	Low Temperature Storage Test	Keep in -30 ±2℃ 96 hrs Surrounding temperature, then storage at normal condition 4hrs.			
3	High Temperature / High Humidity Storage Test	Keep in +60 ℃ / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)			
4	Temperature Cycling Storage Test	-30°C → +25°C → +80°C → +25°C (30mins) (5mins) (30mins) (5mins) 10 Cycle Surrounding temperature, then storage at normal condition 4hrs.			
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance : 15°C~35°C 2. Humidity relative : 30%~60% 3. Energy Storage Capacitance(Cs+Cd) : 150pF±10% 4. Discharge Resistance(Rd) : 330Ω±10% 5. Discharge, mode of operation : Single Discharge (time between successive discharges at least			
6	Vibration Test (Packaged)	 1 sec) (Tolerance if the output voltage indication : ±5%) 1. Sine wave 10~55 Hz frequency (1 min/sweep) 2. The amplitude of vibration :1.5 mm 3. Each direction (X \ Y \ Z) duration for 2 Hrs 			
7	Drop Test (Packaged)	Packing Weight (Kg 0 ~ 45.4 45.4 ~ 90.8 90.8 ~ 454 Over 454 Drop Direction : %1 corner / 3 e	122 76 61 46		



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ±5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

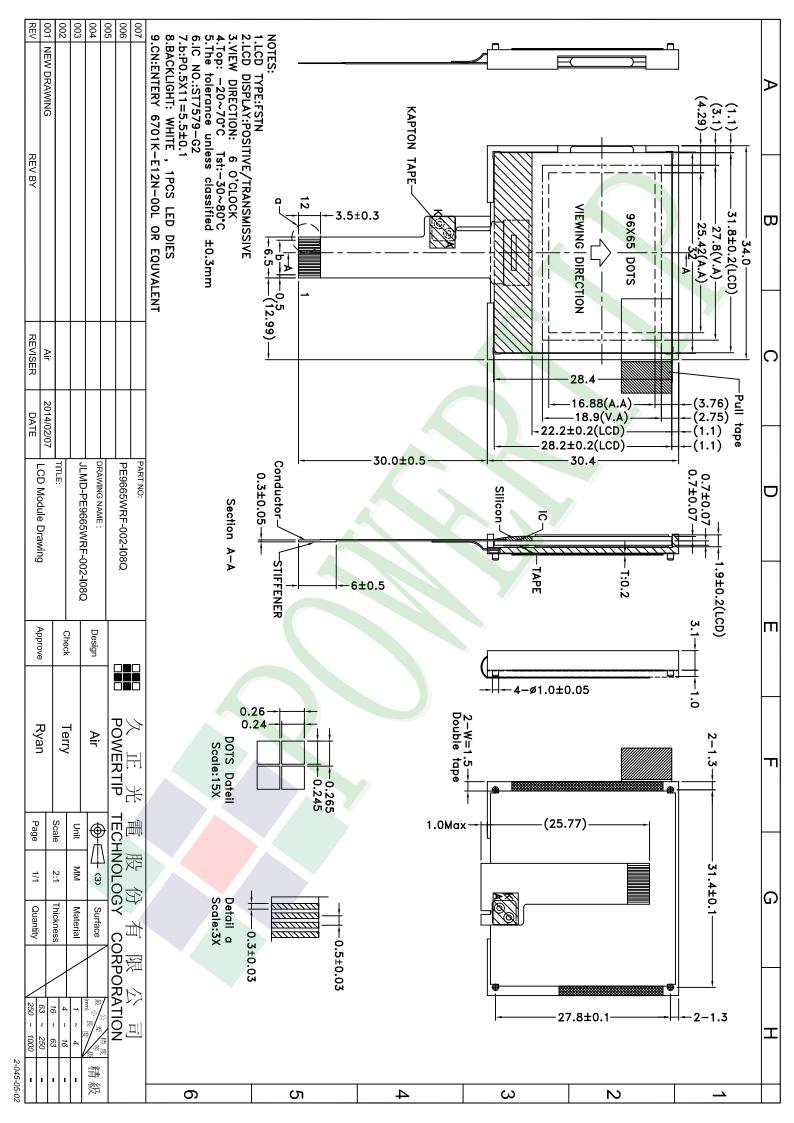
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact Ver.001 LCM包裝規格書 LCM Packaging Specifications Ryan Air Terry Documents NO. JPKG-PE9665WRF-002-I08Q (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) No. Item Model Dimensions (mm) 1Pcs Weight Quantity Total Weight PE9665WRF-002-I08Q 1 成品 (LCM) 34.0 X 30.4 X 3.1 1296 0.0047 6.0912 2 多層薄膜(1)POF 19"X350X0.015 OTFILM0BA03ABA 6 3 TRAY 盤 (2)Tray 352 X 260 X 10.8 60 TY00000000230 0.1 6.0 4 內盒(3)Product Box BX36627063ABBA 393 X 274 X 68 6 1.6152 0.2692 5 保利龍板(4)Polylon board OTPLB00PL08ABA 550 X 393 X 20 0.0284 0.0568 6 外紙箱(5)Carton 570 X 410 X 265 BX57041027CCBA 1.4208 1.4208 7 8 9 15.18 Kg±10% 2. 一整箱總重量 (Total LCD Weight in carton): 3. 單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity per box : no per tray x no of tray 24 216 (2)Total LCM quantity in carton: quantity per box x no of boxes 216 1296 6 Use empty tray 空盤 (4)保利龍板 (1)多層薄膜 Polylon board **POF** Put products into the tray (2)TRAY 盤 Trav (5)外紙箱 Carton Tray stacking (3)內盒 Product Box 特 記 事 項 (REMARK) 3.可適用於單品包裝 1. Label Specifications: 斜角 Detail B It's also suitable to Panel 依廠內標準作業 圓角 Tray 1 2.TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.